

ISSN: 0970-020 X; CODEN: OJCHEG Oriental Journal of Chemistry 2011, Vol. 27, No. (1): Pg. 265-269

http://www.orientjchem.org

Effect of Annealing on the Activation Energy of Thin Films of Manganese Sulphide, Copper Phthalocyanine and Multilayer Manganese Sulphide-Copper Phthalocyanine from their Electrical Studies

SHAJI VARGHESE¹ and MERCY IYPE²

¹Department of Physics, St.Thomas College,Kozhencherry, Kerala (India). ²Department of Chemistry, Marthoma College,Tiruvalla, Kerala (India). E-mail: shajiv55@gmail.com, mercy58@gmail.com

(Received: December 05, 2010; Accepted: January 11, 2011)

ABSTRACT

Manganese Sulphide (MnS) thin films are prepared onto glass substrates by chemical bath deposition (CBD) technique. Thin films of Copper phthalocyanine (CuPc) are also sublimed onto glass substrates in high vacuum at room temperature. Multi layer MnS- CuPc thin films are obtained from MnS films grown on glass substrates by CBD technique and subsequently vacuum subliming CuPc onto them. These films are annealed in air at different temperatures. Electrical conductivity studies are made separately on MnS, CuPc and multi layer MnS-CuPc thin films. Thermal activation energy of the as deposited and annealed samples are determined from the Arrhenius plot. It is found that the activation energy decreases with annealing temperature. This may be due to the reduction in trap sites during annealing.

Key words: Annealing, Activation Energy, Thin Filsm, Electrical Studies.

INTRODUCTION

In the search for low-cost solar energy materials, organic – inorganic photovoltaic junctions in thin-film configuration deserves great attention. The first observations in this field have been made on inorganic semiconducting crystals by Horowitz and Garnier¹ who have investigated the GaAs-PT (PT=poly thiophene) n-p hetero junction, followed by Frank *et al.*² who studied the CdS- PMeT (PMeT=poly(3-methylthiophene)) Schottky junction.

In both the cases the polymer was electrochemically grown on single crystals of the inorganic semi conductors. Later, investigations were done on thin films CdS-PMeT solid state junctions³⁻⁷. P.Chartier et al studied the hybrid organic-inorganic photovoltaic junction of CdSe- poly(3methylthiophene) thin films⁸.

MnS has a direct band gap and can be used as window material in photovoltaic solar cells. Direct energy gap materials result in large optical absorption which in turn permits the use of thin layers of active material. The semiconducting nature of MnS films is found to be p-type⁹.

Phthalocyanines are one of the most widely investigated group of materials due to their potential applications as organic dyes, organic photoconductors, and gas sensors¹⁰⁻¹². These organic semiconductors exhibit high chemical and thermal stability. Semiconducting behaviour of all phthalocyanine films is found to be P-type at all temperatures¹³.

EXPERIMENTAL

Preparation of MnS thin films

Chemical bath deposition (CBD) is a technique for controlling the homogeneous precipitation of water insoluble compounds and their solid solution^{22,23}. One of the advantages of CBD is that high quality films can be prepared on large area substrates and this may be called a " zero energy " deposition process. Another advantage of this technique is the convenience of dopping. In this paper we describe the chemical deposition of MnS thin films on pyrex glass substrates by the decomposition of thioacetamide in an alkaline solution containing a Manganese salt^{24,25}. The chemical process consists of the slow release of Mn^{2+} and S^{2-} ions in solution which subsequently condenses on an ion-ion basis on to the glass substrate²⁶.

Stock solutions of 1M Manganese sulfate and 1M thioacetamide are prepared in tridistilled water^{27,28}. A 100 ml deposition bath is prepared by the sequential addition of the following. 15 ml of 1M Manganese sulfate, 4.4 ml of NH_3/NH_4CI (PH 10), 5.4 ml of 50% triethanolamine, 15 ml of 1 M thioacetamide, and the rest deionized water to make upto 100 ml by volume. The glass slides are washed with detergent solution, then with chromic acid and finally rinsed with de ionised water prior to the deposition of the films. Cleaned glass slides are kept vertically on the walls of the container with the deposition mixture. Depositions are done at room temperature for 24 hours. The films are dried in air.

Preparation of CuPc and multi layer MnS-CuPc thin films

The copper phthalocyanine (CuPc) powder used in this study is obtained from Aldrich chemical company Inc: USA (97.99% pure). Thin films of CuPc are deposited at room temperature on to glass substrates and MnS coated glass substrates at a base pressure of 10⁻⁵ Torr using a Hind Hivac Vacuum coating unit. The evaporation is carried out by resistive heating of the CuPc powder from a molybdenum boat and the rate of sublimation is kept constant²⁹.

Thickness of the films are accurately determined by Tolanskys multiple beam interference technique³⁰. Electrical conductivity is measured using the standard two probe method with a programmable Keithley electrometer (Model No. 617) and a constant current source. Ohmic contacts are made by thin copper strands which are fixed by Silver paste. The film is loaded on the hollow copper block of the conductivity cell. Conductivity measurements are performed in the temperature range 320-505K under a vacuum of 10⁻³ Torr to avoid any type of contamination. Temperature is monitored using a Chromel-Alumel thermocouple attached to the substrate.

RESULTS AND DISCUSSION

Electrical studies are done to determine the thermal activation energy and the effect of annealing on activation energy. The studies are carried out in the temperature range 320-505 K in a vacuum of 10^{-3} Torr to avoid contamination of the film. The resistance R is noted at regular intervals of 5K.

The temperature dependance on resistance is expressed as,

$$R = R_{o} \exp(-Ea/KT)$$

where Ea is the thermal activation energy and K is the Boltzmann constant.

The activation energy is obtained using the relation,

 $\sigma = \sigma_{o} \exp(-\Delta Ea/KT)$

where σ is the carrier conductivity, ΔEa is the activation energy, K is the Boltzmann constant and T is the temperature in absolute scale.

The electrical conductivity as a function of inverse of temperature of as deposited and annealed MnS films are given in Fig.1. Fig. 2 represents similar plots of as deposited and annealed samples of CuPc films. Fig.3 gives plots of as deposited and annealed samples of multi layer MnS-CuPc. From the slopes of these graphs, activation energies are determined. The activation energy of the samples varies with annealing temperature. Each graph has three linear regions which give E_1 , E_2 , and E_3 . The activation energies in the intrinsic region (E_1) and impurity scattering

regions (E_2 and E_3) are calculated. Tables 1, 2 & 3 represents variation of activation energies with annealing temperatures for MnS, CuPc and multi layer MnS-CuPc films respectively. The change in carrier activation energy is indicated by the change in the slope of the plot. Multiple donor and acceptor levels exist within the forbidden energy gap and as temperature is lowered the deeper levels become progressively frozen out. The activation energy measurements provide a measure of the trapping levels. It has been reported that the removal of oxygen causes a redistribution of traps and hence a drop in thermal activation energy³¹]. Sussman has reported that the distribution of trapping sites is altered by annealing³².

Table 1: Variation of Activation Energy with annealing temperature for MnS films of thickness

Samples	Activation energy (ev)		
	E,	E ₂	E ₃
 As deposited Annealed 523 K 	03323 0.3181	0.2415 0.2070	0.1974 0.1391
3. Annealed 573 K	0.2940	0.1961	0.1378

Table 2: Variation of Activation Energy with annealing temperature for CuPc films of Thickness 2180 A

Samples	Activation energy (ev)		
	E ₁	E ₂	E ₃
 As deposited Annealed 523 K Annealed 573 K 	0.7065 0.5859 0.5003	0.6091 0.5803 0.2710	0.1851 0.1725 0. 0551

Table 3: Variation of Activation Energy with annealing temperature for Multi layer MnS-CuPc films of thickness 6630 A

Samples	Activation energy (ev)			
	E,	E ₂	E ₃	
1. As deposited	0.7991	0.5476	0.1949	
2. Annealed 523 K	0.6086	0.5403	0.1894	
3. Annealed 573 K	0.3525	0.3269	0.1860	



Fig. 1: Graph of Electrical conductivity Vs inverse of temperature of as deposited and annealed MnS thin films



Fig. 3: Graph of Electrical conductivity Vs inverse of temperature of as deposited and annealed multi layer MnS- CuPc thin films



Fig. 2: Graph of Electrical conductivity Vs inverse of temperature of as deposited and annealed CuPc thin films

CONCLUSION

Manganese Sulphide thin films are prepared on glass substrates by chemical bath deposition method. Thin films of Copper Phthalocyanine are sublimed onto glass substrates in high vacuum at room temperature. Multi layer MnS-CuPc thin films are obtained from MnS films grown on glass substrates by CBD technique and subsequently vacuum subliming CuPc onto them. Electrical conductivity and thermal activation energy of the as deposited and annealed MnS, CuPc and multi layer MnS-CuPc thin films have been studied. Electrical conductivity by thermal activation process is found to involve different conduction mechanisms. For CuPc in the high temperature range, intrinsic conductivity by holes are found to contribute to the conduction process whereas in the low temperature range impurities are found to play an active role. Annealing causes the reduction in activation energy for all the films. This may be due to the reduction in trap sites because of annealing.

ACKNOWLEDGMENTS

This paper is the result of work done by Dr. Mercy lype in a project funded by KSCSTE.

REFERENCES

- G. Horowitz, F.Garnier, Solar Energy Materials. 13: 47 (1986).
- A.J. Frank, S. Glenis, A.J. Nelson, *J.Phys. Chem.* 93: 3818 (1989).
- P. Chartier,B. Ba, J. Ebothe,N. Alonso Vante, H. Nguyen Cong, *J.Electroanal.Chem.*, **138**: 381 (1982).
- C. Bouchenaki, B. Ullrich, J.P. Zielinger, H. Nguyen Cong, P. Chartier, *J. Crystal Growth*, **101**: 797 (1990).
- 5. C.Sene, H. guyen Cong, P. Chartier, *J. Mater. Sci: Mater. In Electronics*, **8**: 85 (1997).
- H. Nguyen Cong, C. Sene, P.Chartier, Sol. Energy Mater. Sol. Cells, 40: 261 (1996).
- H. Nguyen Cong, C. Sene, P.Chartier, Sol. Energy Mater. Sol. Cells, 30: 209 (1993).
- 8. P.Chartier, H. Nguyen Cong, C.Sene, *Sol. Energy Mater. Sol. Cells*, **52**: 413 (1998).
- K.Okamoto, S.Kawai, Jpn. J.Appl.phys., 1973,12,1130; P.K.Nair,M.T.S.Nair *et al., Sol. Energy Mater. Sol. Cells*, 1998, 52, 313-344.
- 10. K. Nebesny, G.E.Collins, P.A.Lee, *Chem.Mater*, **3**: 829 (1991).
- M.Pope, C.E.Swenberg, Electronic Processing anic Crystals, Clarendoness, Oxford (1992).
- 12. C.W.Tong, Appl. Phys. Lett., 48: 183 (1986).
- 13. Y. Sadaoka, T.A. Jones, W. Gopel, *J. Mater. Sci. Lett.*, **8**: 1095 (1989).
- 14. H.Cachet, h. Essaaidi, M.Froment, G.Maurin, *J.Electroanal Chem.*, **396**: 175 (1995).
- S. Gorer, G. Hodes, *J.Phys. Chem.*, **98**: 5338 (1994).
- M.T.S.Nair, P.K.Nair, H.M.K.K.Pathiarana, R.A.Zingaro, E.A.Meyers, J. Electrochem. Soc., 140: 2987 (1993).
- 17. J.M.Gracia-Jimenez,G.Martinez- Montes, R.SilvaGonzales,J. Electrochem. Soc., 139:

2048 (1992).

- K.C. Mandal, O.Savadogo, *J. Mater.Sci. Lett.*, 10: 1446 (1991).
- Y.Ueno, H.Kaigawa, T.Ohashi, T.Sugiura, H.Minoura, *Sol.Energy Mater.*, **15**: 421 (1987).
- R.A.Boudreau, R.D.Rauh, *J.Electrochem.* Soc., 130: 513 (1983).
- D.R.Pratt ,M.E.Langmuir, R.A.Boudreau, R.D.Rauh, *J.Electrochem. Soc*, **128**: 1627 (1981).
- K.L.Chopra, R.C.Kainthla, D.K.Pandya, A.P.Thakoor, in: G.,Hass,M.H.Francombe, J.L.Vossen(Eds.),Physics of Thin Films, vol.12,Academic Press, New York, 201 (1982).
- 23. Polyvyannyi . J. Russ, In org. Chem: , 26: 561 (1981)
- 24. P.K. Nair, M.T.S. Nair, *Solar cells*, **22**: 103 (1987).
- O.Savadogo, K.C.Mandal, J. Electro chem. Soc., 14: 32 (1994).
- O.Savadogo, Solar energy materials and solar cells, 52: 361-388 (1998).
- O.Savadogo, K.C.Mandal, *Apply.Phys.Lett.*, 63: 12 (1993).
- O.Savadogo, K.C.Mandal, J. Electro chem. Soc., 141: 2871 (1994).
- S.Ambily, C.S.Menon, *Sol. Stat. Commun.*, 94: 485 (1995).
- 30. L.I.Maissel, R.Glang, Handbook of Thin Film Technology, McGraw-Hill, 1983, p. 11-18.
- 31. A.Epstein, B.S.Wildi, *J.Chem.Phys.*, **32**: 324 (1960).
- 32. A.Sussman, J. Appl. Phys., 38: 2748 (1967).
- F. Garnier, *La Recherche, Paris*, **184**: 20 (1996).